



## Nano Scale Disruptive Silicon-Plasmonic Platform for Chip-to-Chip Interconnection

### MS35: Fabrication of second generation beam shapers

Deliverable no.: MS35  
Due date: 1/1/2015  
Actual Submission date: 15/9/2015  
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Work package(s): WP5  
Distribution level: RE<sup>1</sup> (NAVOLCHI Consortium)  
Nature: document, available online in the restricted area of the NAVOLCHI webpage

#### List of Partners concerned

Partner number	Partner name	Partner short name	Country	Date enter project	Date exit project
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*Deliverable Responsible*

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*Executive Summary*

Milestone 35 “fabrication of beam shapers” was completed. All results are reported in the deliverable D57.